

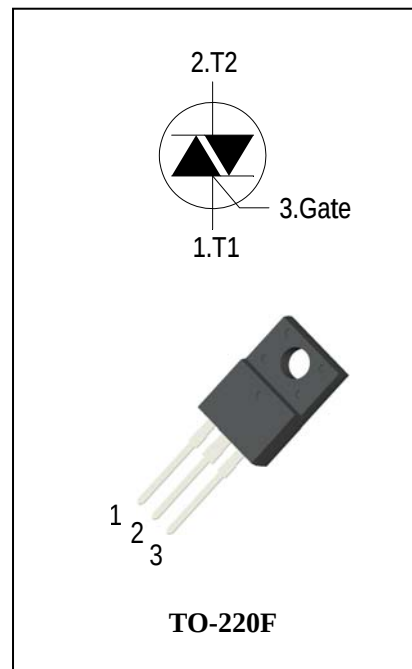
3 Quadrants High temperature Triacs

General Description

High current density due to mesa technology , guaranteed maximum junction temperature 150° C. The ADT30CH triac series is suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, High power motor controls e.g. washing machines and vacuum cleaners, Rectifier-fed DC inductive loads e.g. DC motors and solenoids , motor speed controllers. The heatsink can be reduced, compared to traditional triacs, according to the high performance at given junction temperatures.

Features

- ◆ Repetitive Peak Off-State Voltage: 600V/800V
- ◆ R.M.S On-State Current ($I_{T(RMS)}$)= 30A)
- ◆ High Commutation dv/dt
- ◆ High junction temperature operating capability
- ◆ These Devices are Pb-Free and are RoHS Compliant



Absolute Maximum Ratings

Symbol	Items	Conditions		Ratings	Unit
V_{DRM}	Repetitive Peak Off-State Voltage	$T_j = 25^{\circ}\text{C}$	ADT30CH60F	600	V
V_{RRM}			ADT30CH80F	800	V
$I_{\text{T(RMS)}}$	R.M.S On-State Current	$T_{\text{C}} = 93^{\circ}\text{C}$		30	A
I_{TSM}	Surge On-State Current	$t_p=20\text{ms}(50\text{Hz})/t_p=16.7\text{ms}(60\text{Hz})$		270/285	A
I^2t	I^2t for fusing	$t_p=10\text{ms}$		488	A^2s
di/dt	Critical rate of rise of on-state current	$F = 120 \text{ Hz } T_j = 150^{\circ}\text{C}$ $I_G = 2 \times I_{\text{GT}} , t_r \leq 100 \text{ ns}$		55	$\text{A}/\mu\text{s}$
I_{GM}	Peak Gate Current	$t_p = 20 \mu\text{s } T_j = 150^{\circ}\text{C}$		4	A
$P_{\text{G(AV)}}$	Average Gate Power Dissipation($T_j=150^{\circ}\text{C}$)			1	W
P_{GM}	Peak Gate Power Dissipation($t_p=20\mu\text{s}, T_j=150^{\circ}\text{C}$)			10	W
T_j	Operating Junction Temperature			- 40 ~ 150	$^{\circ}\text{C}$
T_{STG}	Storage Temperature			- 40 ~ 150	$^{\circ}\text{C}$



Electrical Characteristics($T_j = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Items	Conditions		ADT30CH60F/80F			Unit
				S	Blank	B	
I_{DRM}	Peak Forward Reverse Blocking Current	$V_{\text{DRM}} = V_{\text{RRM}}, T_j = 25^\circ\text{C}$	Max.	10			μA
I_{RRM}		$V_{\text{DRM}} = V_{\text{RRM}}, T_j = 150^\circ\text{C}$		8.5			mA
V_{TM}	Peak On-State Voltage	$I_{\text{TM}} = 42\text{A}, t_p = 380 \mu\text{s}$	Max.	1.5			V
V_{GD}	Q1-Q2-Q3	Non-Trigger Gate Voltage $V_D = V_{\text{DRM}}, R_L = 3.3 \text{ k}\Omega$ $T_j = 150^\circ\text{C}$	Min.	0.15			V
V_{GT}	Q1-Q2-Q3	Gate Trigger Voltage $V_D = 12\text{V}, R_L = 33\Omega$	Max.	1.3			V
I_{GT}	Q1-Q2-Q3	Gate Trigger Current	Max.	10	35	50	mA
I_{H}	Q1-Q2-Q3	Holding Current $I_T = 0.1\text{A}$	Max.	20	50	75	mA
I_{L}	Q1-Q3	Latching Current $I_G = 1.2 I_{\text{GT}}$	Max.	20	80	90	mA
	Q2			35	90	110	
dV/dt	Critical Rate of Rise of Off-State Voltage	$V_D = 2/3 V_{\text{DRM}}$ gate open $T_j = 150^\circ\text{C}$	Min.	500	1000	1500	V/ μs
(dV/dt)c	Critical Rate of Change of Commutating Voltage	$V_D = 400\text{V}, T_j = 150^\circ\text{C}$ (dI/dt)c=-16A/ms	Min.	1	15	20	V/ μs
$R_{\text{th(j-c)}}$	Junction to case (AC)		Max.	1.6			$^\circ\text{C/W}$
$R_{\text{th(j-a)}}$	Junction to ambient		Max.	60			$^\circ\text{C/W}$

FIG.1: Triac quadrant are defined and the gate trigger test circuit

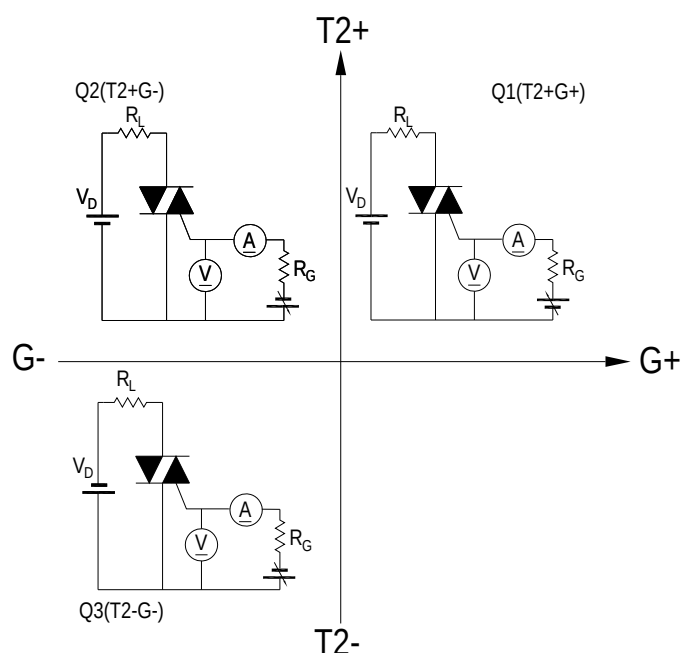


FIG.2: Maximum on-state power dissipation

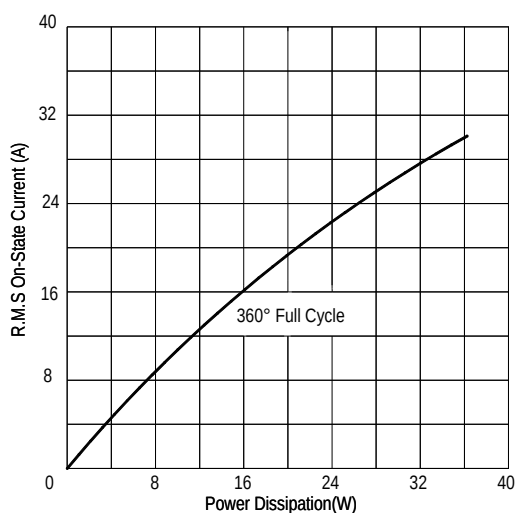


FIG.4: Maximum transient thermal impedance

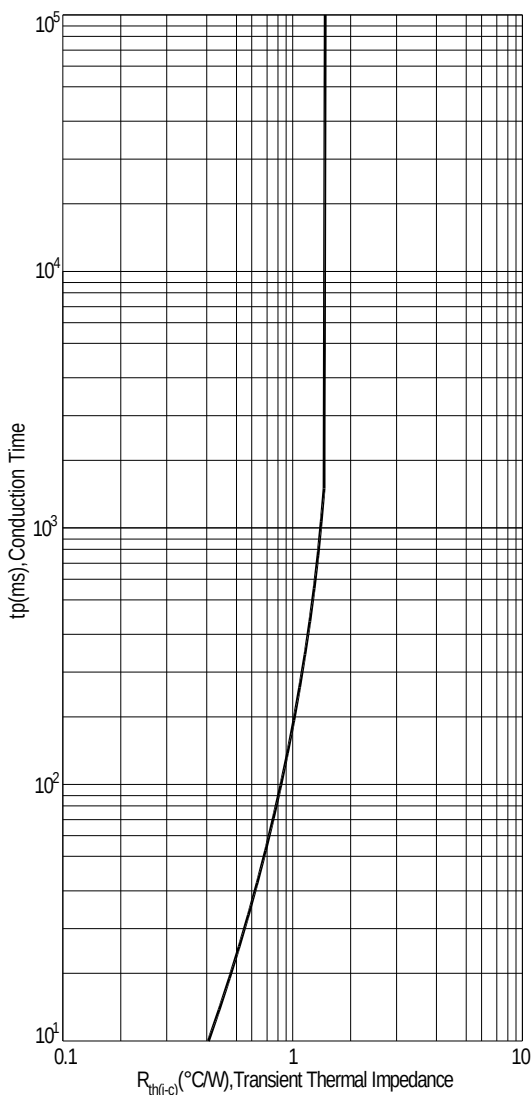


FIG.3: Typical RMS on-state current VS Allowable case Temperature

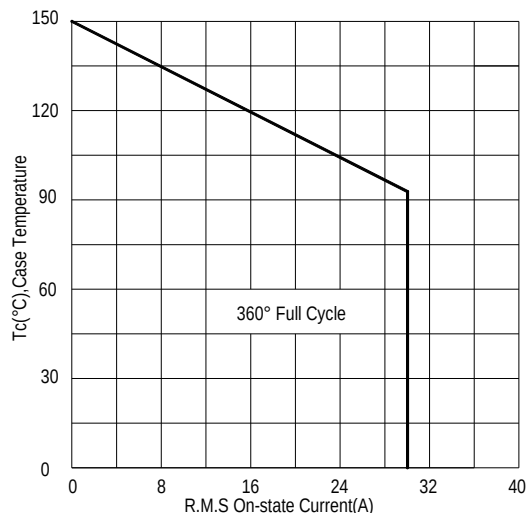


FIG.5: Rated surge on-state current (Non-Repetitive)

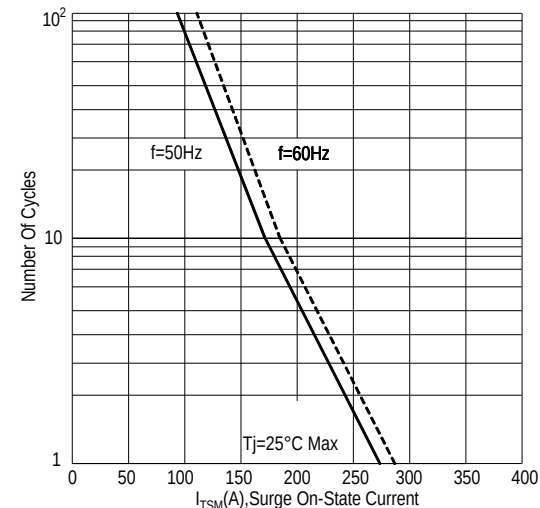


FIG.6: Gate trigger current VS Junction temperature

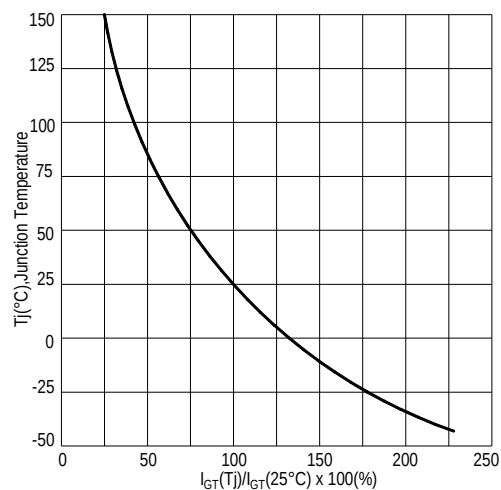


FIG.7:Holding current and Latching current VS Junction temperature

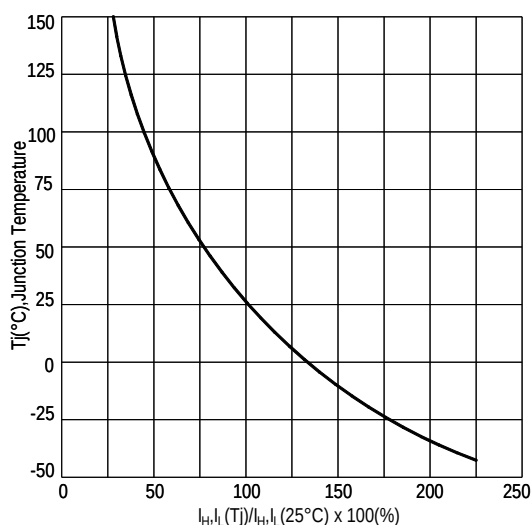


FIG.8: Gate trigger voltage VS Junction temperature

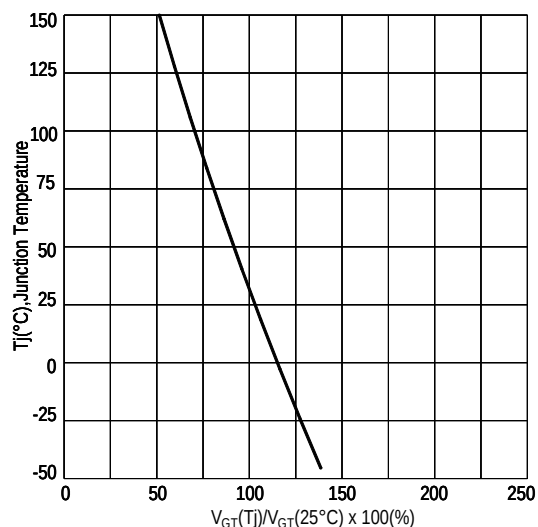
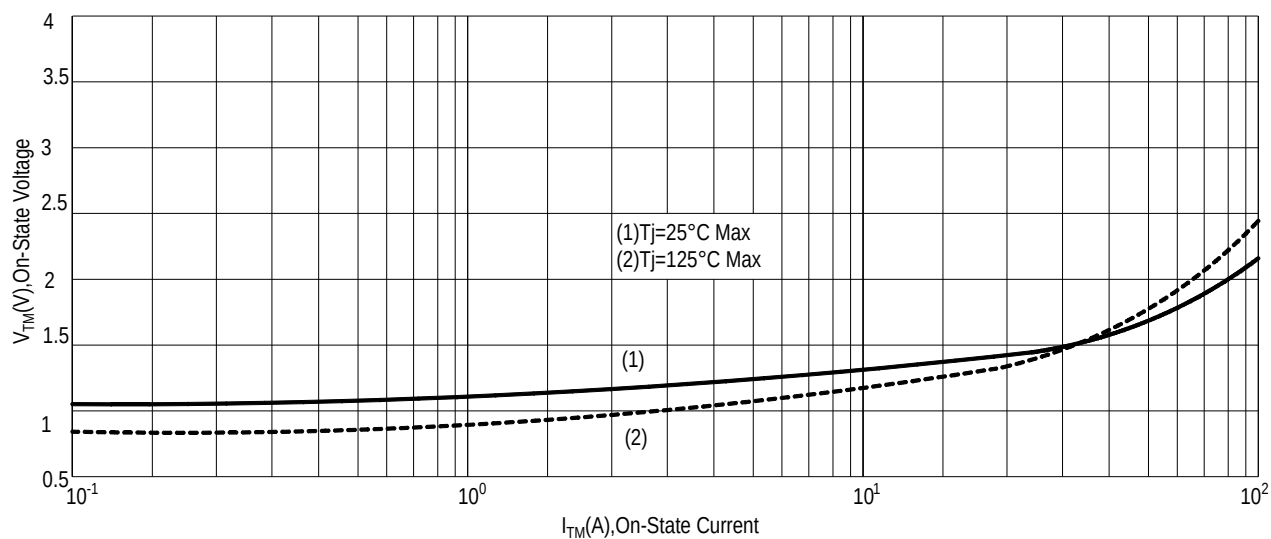
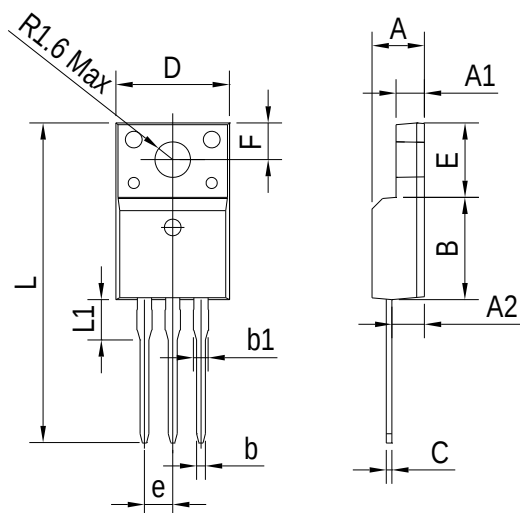


FIG.9: On-state characteristics(Max)



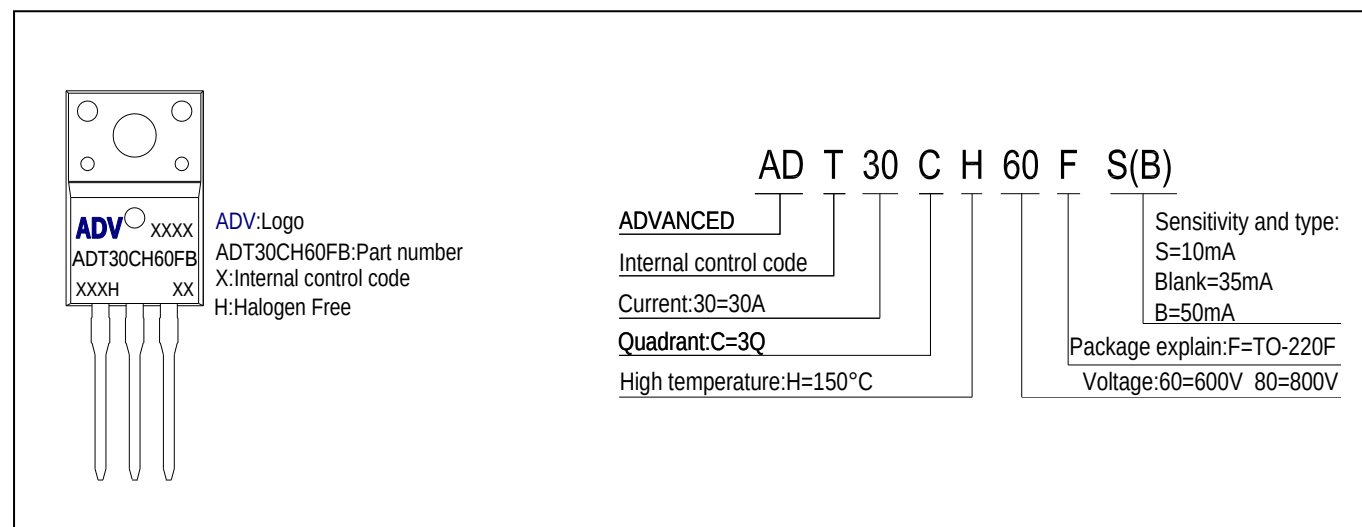
PACKAGE MECHANICAL DATA

TO-220F Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.300	4.800	0.169	0.189
A1	2.400	2.700	0.094	0.106
A2	2.500	3.000	0.098	0.118
B	8.800	9.300	0.346	0.367
b	0.600	0.950	0.023	0.037
b1	1.100	1.700	0.043	0.067
C	0.500	0.750	0.020	0.030
D	9.700	10.360	0.382	0.408
E	6.400	6.800	0.252	0.268
e	2.540 TYP		0.100 TYP	
F	3.300 REF		0.130 REF	
L	28.000	30.000	1.102	1.181
L1	2.900	3.630	0.114	0.143

Making Diagram



Ordering information

Part number	Package	Marking	Packing	Quantity
ADT30CH60F#	TO-220F	ADT30CH60F#	Tube	50pcs
ADT30CH80F#	TO-220F	ADT30CH80F#	Tube	50pcs

Note: # = Gate Trigger Current Sensitivity and type

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